International

AUIRFL024N

Features

- Advanced Planar Technology
- Low On-Resistance
- Dynamic dV/dT Rating
- 150°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified*

Description

Specifically designed for Automotive applications, this cellular design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.





G	D	S
Gate	Drain	Source

Bees next number	Deckers Ture	Standard P	ack	Orderable Part Number
Base part number	Package Type	Form	Quantity	Orderable Part Number
	COT 000	Tube	95	AUIRFL024N
AUIRFL024N	AUIRFL024N SOT-223		2500	AUIRFL024NTR

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V ®	4.0	
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V 3	2.8	
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 10V ⑤	uous Drain Current, V _{GS} @ 10V ^⑤ 2.3	
I _{DM}	Pulsed Drain Current ①	11.2	
P _D @T _A = 25°C	Power Dissipation (PCB Mount) 6	2.1	w
P _D @T _A = 25°C	Power Dissipation (PCB Mount) ^⑤	1.0	VV
	Linear Derating Factor (PCB Mount) 5	8.3	mW/°C
V _{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) 2	214	mJ
I _{AR}	Avalanche Current ①	2.8	А
E _{AR}	Repetitive Avalanche Energy 05	0.1	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns
ТJ	Operating Junction and	-55 to + 150	°C
T _{STG}	Storage Temperature Range		
Thermal Re	sistance		
-			6

	Parameter	Тур.	Max.	Units
R _{0JA}	Junction-to-Ambient (PCB mount, steady state) ^⑤	90	120	°C/W
R _{0JA}	Junction-to-Ambient (PCB mount, steady state) ®	50	60	

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Static Electrical Characteristics @ $T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_{D} = 250\mu A$
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		0.056		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			75	mΩ	V _{GS} = 10V, I _D = 2.8A ④
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
gfs	Forward Transconductance	3.0			S	$V_{DS} = 25V, I_D = 1.6A$
I _{DSS}	Drain-to-Source Leakage Current			25	μA	$V_{DS} = 55V, V_{GS} = 0V$
				250		$V_{DS} = 44V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 20V
	Gate-to-Source Reverse Leakage			-100		V _{GS} = -20V
D	Dynamia Electrical Oberratariatica $\otimes \mathbf{T} = 0\mathbf{E}^{\circ}\mathbf{O}$ (unloss otherwise encoding)					

Dynamic Electrical Characteristics @ $T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Qg	Total Gate Charge			18.3		I _D = 1.68A
Q _{gs}	Gate-to-Source Charge			3.0	nC	$V_{DS} = 28V$
Q_{gd}	Gate-to-Drain ("Miller") Charge			7.7		V_{GS} = 10V, See Fig. 6 and 9 \circledast
t _{d(on)}	Turn-On Delay Time		8.1			$V_{DD} = 28V$
t _r	Rise Time		13.4		ns	I _D = 1.68A
t _{d(off)}	Turn-Off Delay Time		22.2			$R_{G} = 24 \Omega$
t _f	Fall Time		17.7			$R_D = 17\Omega$, See Fig. 10 ④
C _{iss}	Input Capacitance		400			$V_{GS} = 0V$
C _{oss}	Output Capacitance		145		pF	$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		60			f = 1.0MHz, See Fig. 5

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			2.8		MOSFET symbol
	(Body Diode)				А	showing the
I _{SM}	Pulsed Source Current			11.2		integral reverse _G 🕌 🗍
	(Body Diode) ①					p-n junction diode.
V _{SD}	Diode Forward Voltage			1.0	V	$T_J = 25^{\circ}C, I_S = 1.68A, V_{GS} = 0V$ (4)
t _{rr}	Reverse Recovery Time		35	53	ns	T _J = 25°C, I _F = 1.68A
Q _{rr}	Reverse Recovery Charge		50	75	nC	di/dt = 100A/µs ④
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

- Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- \bigcirc V_{DD} = 25V, starting T_J = 25°C, L = 54.7mH R_G = 25 Ω , I_{AS} = 2.8A. (See Figure 12)
- 3 I_{SD} \leq 1.68A, di/dt \leq 155A/µs, $V_{DD} \leq V_{(BR)DSS},$ $T_{J} \leq$ 150°C .
- ④ Pulse width \leq 300µs; duty cycle \leq 2%.
- S When mounted on FR-4 board using minimum recommended footprint.
- Image: When mounted on 1 inch square copper board, for comparison with other SMD devices.

























Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage







Fig 7. Typical Source-Drain Diode Forward Voltage Fig 8. Maximum Safe Operating Area





Fig 9a. Basic Gate Charge Waveform



Fig 9b. Gate Charge Test Circuit



Fig 10a. Switching Time Test Circuit



Fig 10b. Switching Time Waveforms



Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient





Fig 12a. Unclamped Inductive Test Circuit





Fig 12b. Unclamped Inductive Waveforms





SOT-223 (TO-261AA) Package Outline

Dimensions are shown in milimeters (inches)



SOT-223 (TO-261AA) Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



SOT-223 (TO-261AA) Tape & Reel Information

Dimensions are shown in milimeters (inches)



4 INCLUDES FLANGE DISTORTION @ OUTER EDGE.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



Qualification Information[†]

			Automotive			
c		(per AEC-Q101) ^{††}				
		qualification.	This part number(s) passed Automotive IR's Industrial and Consumer qualification ed by extension of the higher Automotive			
Moisture Sensitivity Level		SOT-223	MSL1			
	Machine Model		Class M2 (+/- 150V) ^{†††}			
		AEC-Q101-002				
	Human Body Model		Class H1A (+/- 350V) ^{†††}			
ESD			AEC-Q101-001			
Charged Device Model		Class C5 (+/- 2000V) ^{†††}				
			AEC-Q101-005			
RoHS Compliant	RoHS Compliant Yes		Yes			

† Qualification standards can be found at International Rectifier's web site: <u>http://www.irf.com/</u>

tt Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.

††† Highest passing voltage.



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Revision History

Date	Comments	
3/26/2014	Updated part marking on page 7	
3/20/2014	 Updated data sheet with new IR corporate template 	



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